

Part Number: APB2012SURKCGKC

Hyper Red
Green

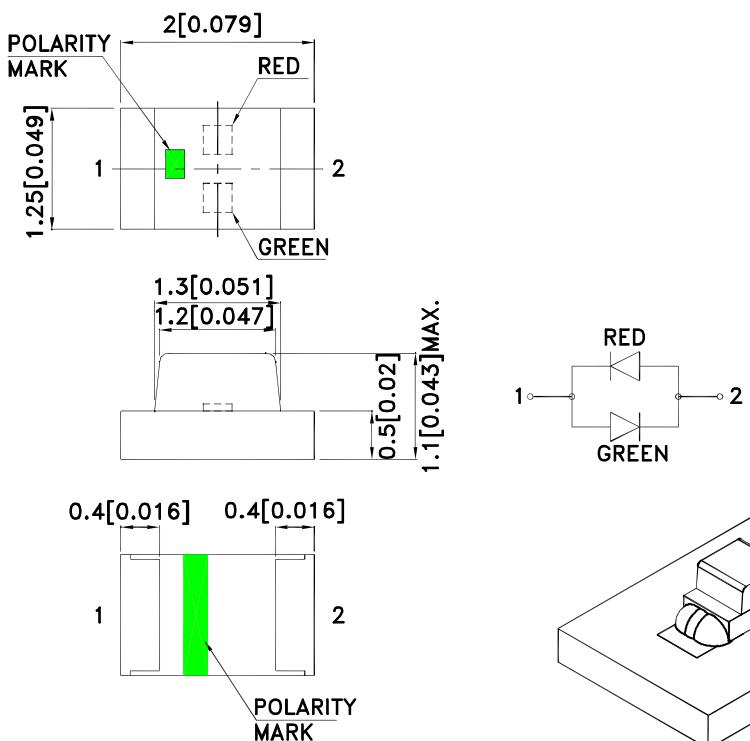
Features

- 2.0mmx1.25mm SMT LED, 1.1mm thickness.
- Bi -color, Low power consumption.
- Wide viewing angle.
- Ideal for backlight and indicator.
- Package : 2000pcs / reel.
- Moisture sensitivity level : level 3.
- RoHS compliant.

Description

The Hyper Red source color devices are made with Al-GaInP on GaAs substrate Light Emitting Diode.
The Green source color devices are made with AlGaInP on GaAs substrate Light Emitting Diode.

Package Dimensions



Notes:

1. All dimensions are in millimeters (inches).
2. Tolerance is $\pm 0.15(0.006")$ unless otherwise noted.
3. The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.
4. The device has a single mounting surface. The device must be mounted according to the specifications.



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Selection Guide

Part No.	Dice	Lens Type	I _v (mcd) [2] @ 20mA		Viewing Angle [1]
			Min.	Typ.	
APB2012SURKCGKC	Hyper Red (AlGaInP)	Water Clear	120	200	150°
			*40	*80	
	Green (AlGaInP)		20	50	
			*20	*50	

Notes:

1. θ1/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.

2. Luminous intensity/ luminous Flux: +/-15%.

* Luminous intensity value is traceable to the CIE127-2007 compliant national standards.

Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Device	Typ.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Hyper Red Green	645 574		nm	I _f =20mA
λD [1]	Dominant Wavelength	Hyper Red Green	630 570		nm	I _f =20mA
Δλ1/2	Spectral Line Half-width	Hyper Red Green	28 20		nm	I _f =20mA
C	Capacitance	Hyper Red Green	35 15		pF	V _F =0V;f=1MHz
V _F [2]	Forward Voltage	Hyper Red Green	1.95 2.1	2.5 2.5	V	I _f =20mA

Notes:

1. Wavelength: +/-1nm.

2. Forward Voltage: +/-0.1V.

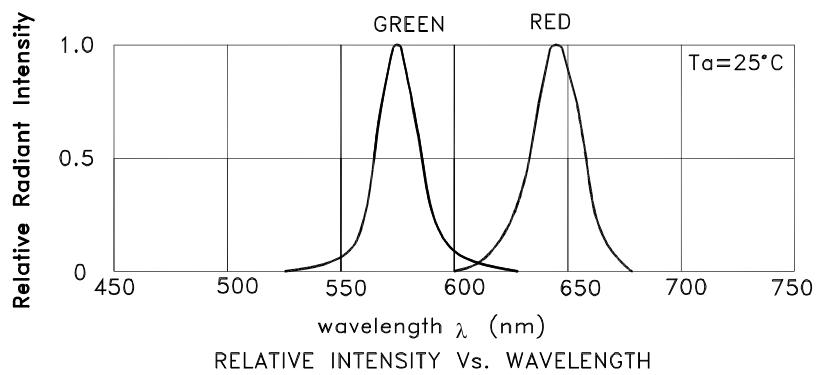
3. Wavelength value is traceable to the CIE127-2007 compliant national standards.

Absolute Maximum Ratings at TA=25°C

Parameter	Hyper Red	Green	Units
Power dissipation	75	75	mW
DC Forward Current	30	30	mA
Peak Forward Current [1]	185	150	mA
Operating Temperature	-40°C To +85°C		
Storage Temperature	-40°C To +85°C		

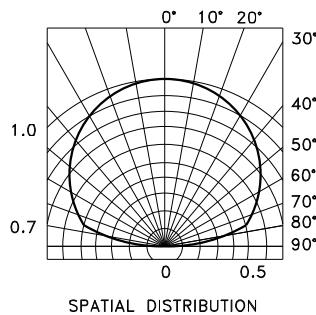
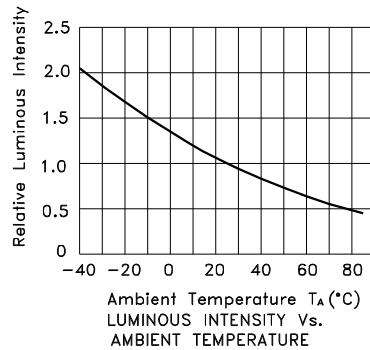
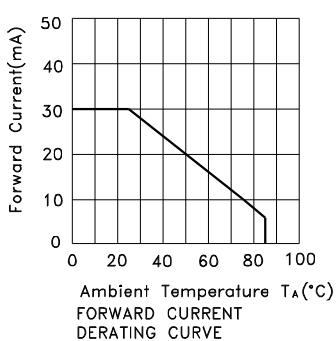
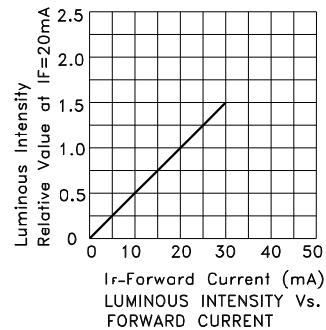
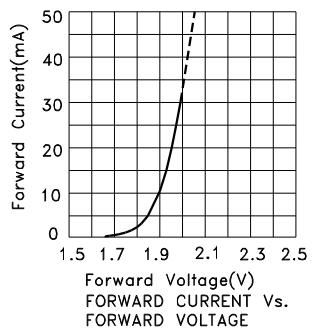
Note:

1. 1/10 Duty Cycle, 0.1ms Pulse Width.

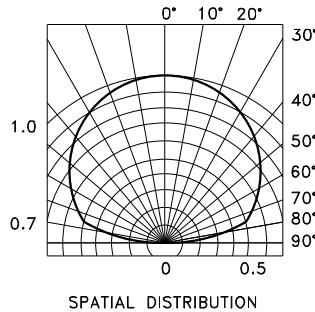
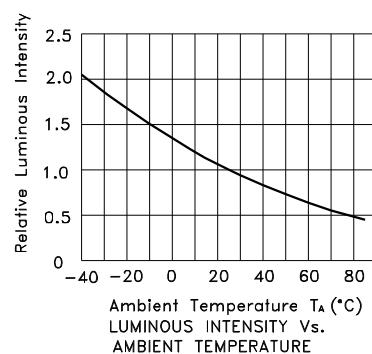
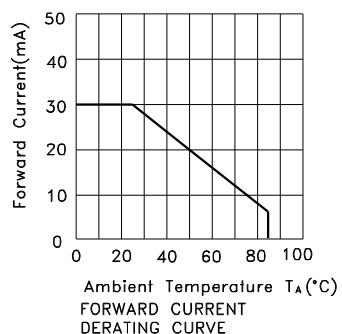
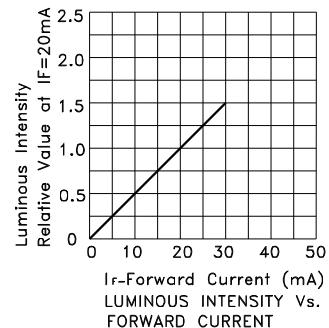
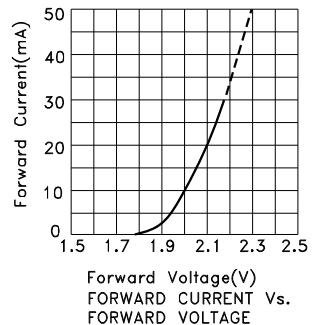


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Hyper Red



Green

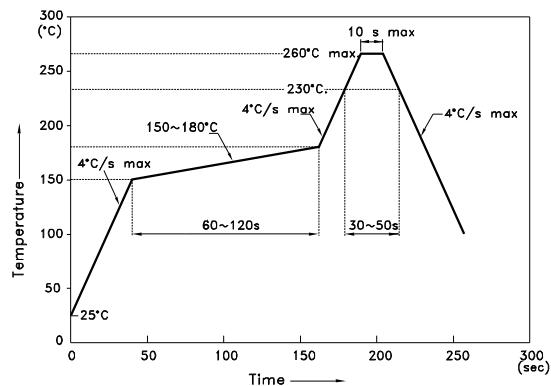


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Reflow soldering is recommended and the soldering profile is shown below. Other soldering methods are not recommended as they might cause damage to the product.

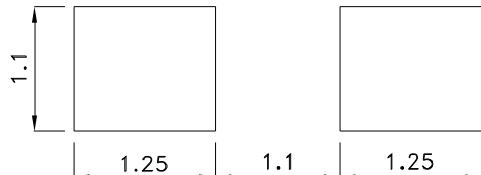
Reflow Soldering Profile For Lead-free SMT Process.



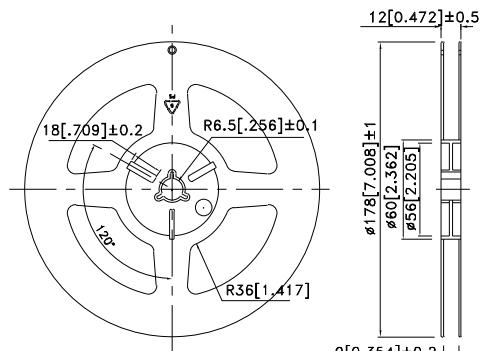
NOTES:

1. We recommend the reflow temperature 245°C(+/−5°C).The maximum soldering temperature should be limited to 260°C.
2. Don't cause stress to the epoxy resin while it is exposed to high temperature.
3. Number of reflow process shall be 2 times or less.

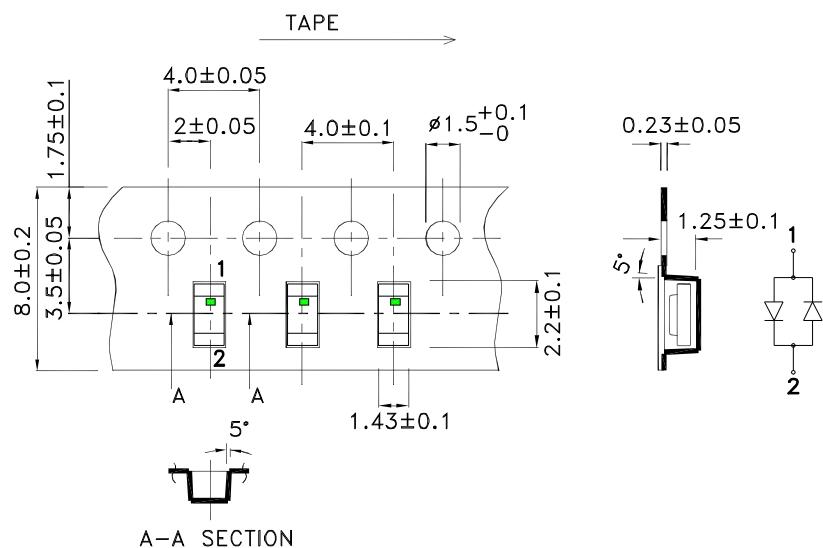
Recommended Soldering Pattern (Units : mm; Tolerance: ± 0.1)



Reel Dimension



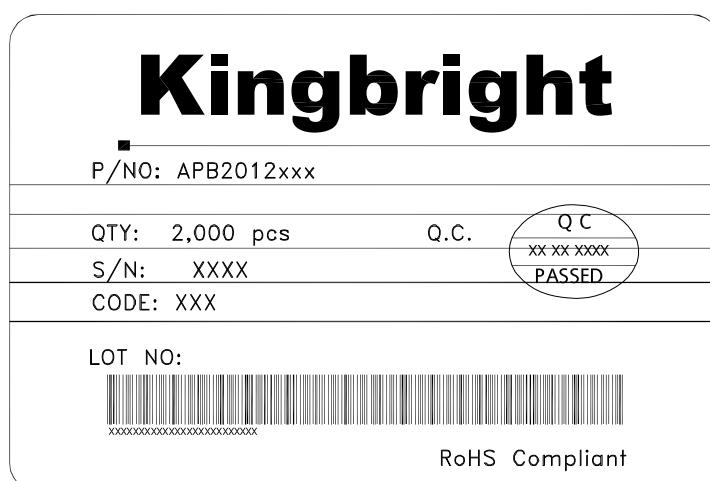
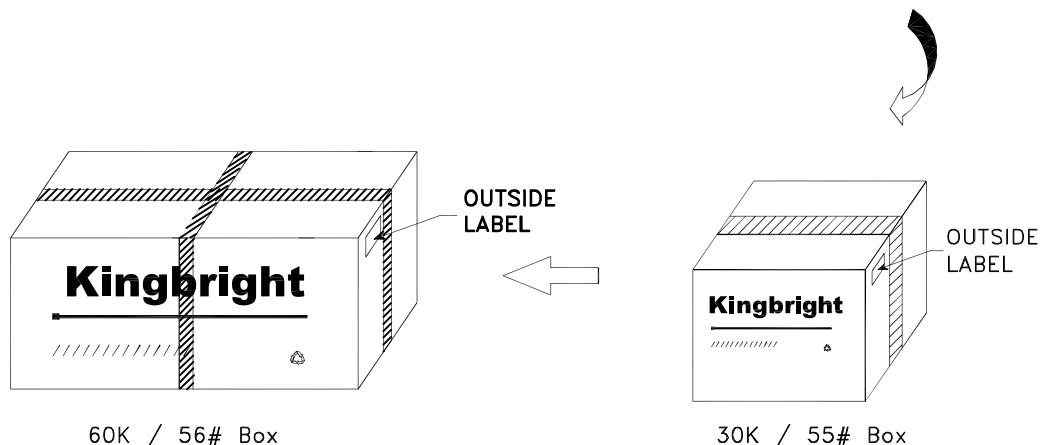
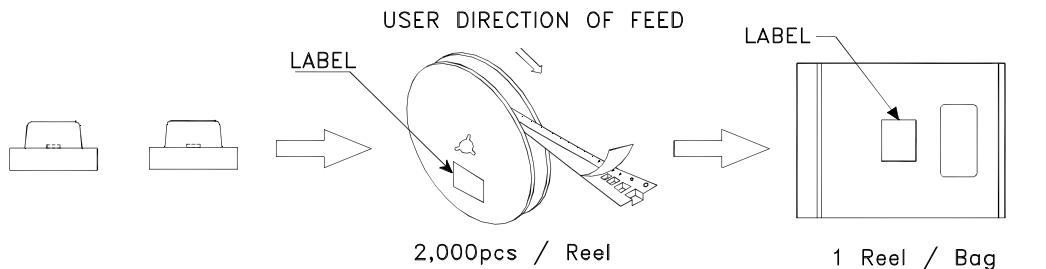
Tape Dimensions (Units : mm)



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PACKING & LABEL SPECIFICATIONS

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All design applications should refer to Kingbright application notes available at
<http://www.KingbrightUSA.com/ApplicationNotes>